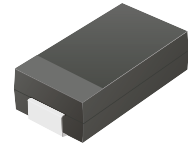


CDBA220-G Thru. CDBA2100-G

Reverse Voltage: 20 to 100 Volts

Forward Current: 2.0 Amp

RoHS Device

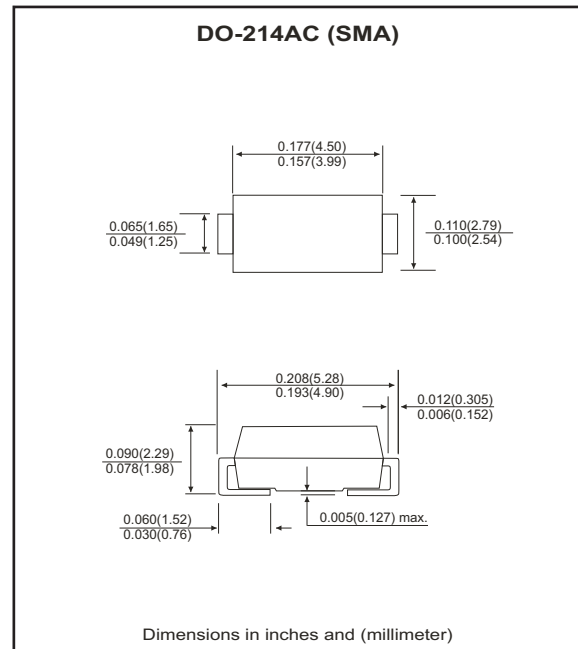


Features

- Ideal for surface mount applications.
- Easy pick and place.
- Plastic package has Underwriters Lab. flammability classification 94V-0.
- Built-in strain relief.
- Low forward voltage drop.

Mechanical data

- Case: JEDEC DO-214AC, molded plastic.
- Terminals: solderable per MIL-STD-750, method 2026.
- Polarity: Color band denotes cathode end.
- Approx. weight: 0.064 grams



Maximum Ratings and Electrical Characteristics

Parameter	Symbol	CDBA 220-G	CDBA 240-G	CDBA 260-G	CDBA 280-G	CDBA 2100-G	Units
Max. repetitive peak reverse voltage	V _{RRM}	20	40	60	80	100	V
Max. DC blocking voltage	V _{DC}	20	40	60	80	100	V
Max. RMS voltage	V _{RMS}	14	28	42	56	70	V
Peak surge forward current, 8.3ms single half sine-wave superimposed on rate load (JEDEC method)	I _{FSM}	50					A
Max. average forward current	I _O	2.0					A
Max. instantaneous forward voltage at 2.0A	V _F	0.50		0.70	0.85		V
Max. DC reverse current at T _A =25 °C rated DC blocking voltage T _A =100 °C	I _R	0.5 10					mA
Max. thermal resistance (Note 1)	R _{θJA} R _{θJL}	75 17					°C/W
Max. operating junction temperature	T _J	125					°C
Storage temperature	T _{STG}	-65 to +150					°C

Notes: 1. Thermal resistance from junction to ambient and junction to lead mounted on P.C.B. with 5.0×5.0 mm copper pad area.

RATING AND CHARACTERISTIC CURVES (CDBA220-G thru CDBA2100-G)

Fig.1 Reverse Characteristics

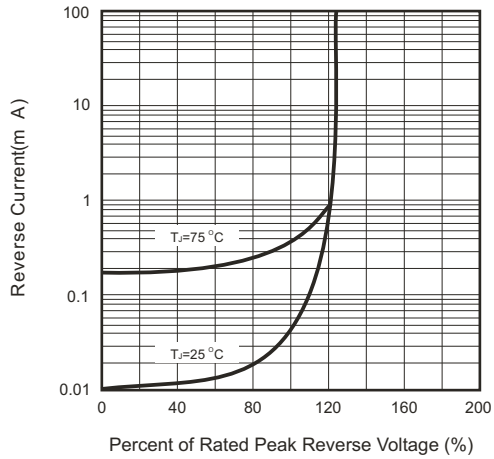


Fig.2 Forward Characteristics

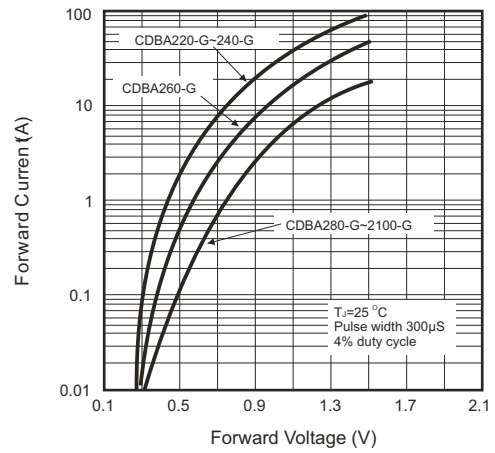


Fig.3 Junction Capacitance

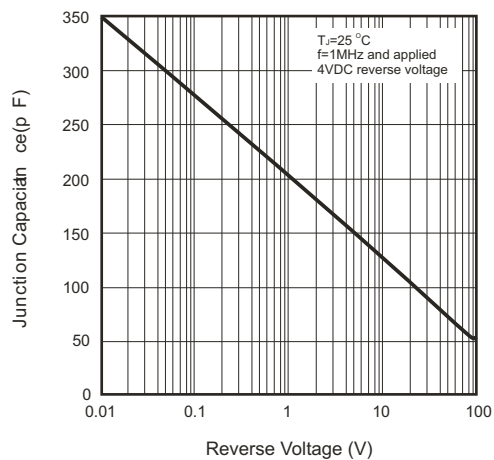


Fig.4 Current Derating Curve

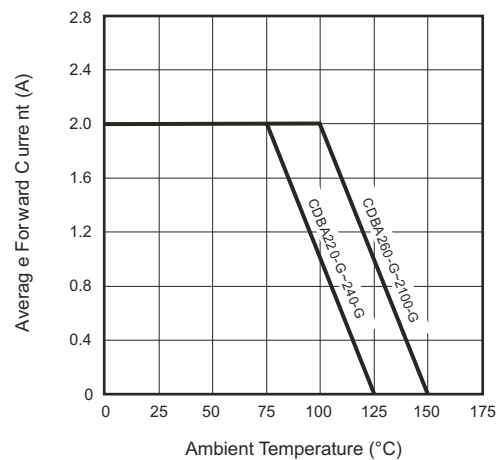
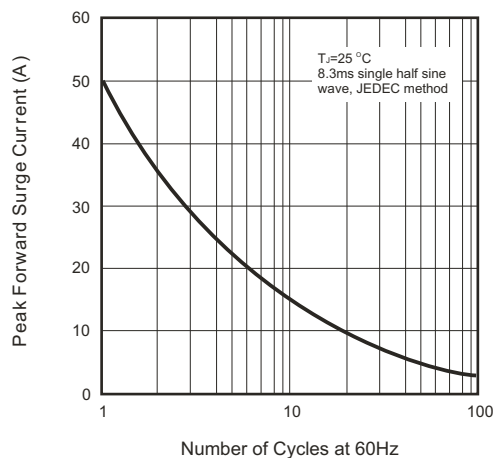
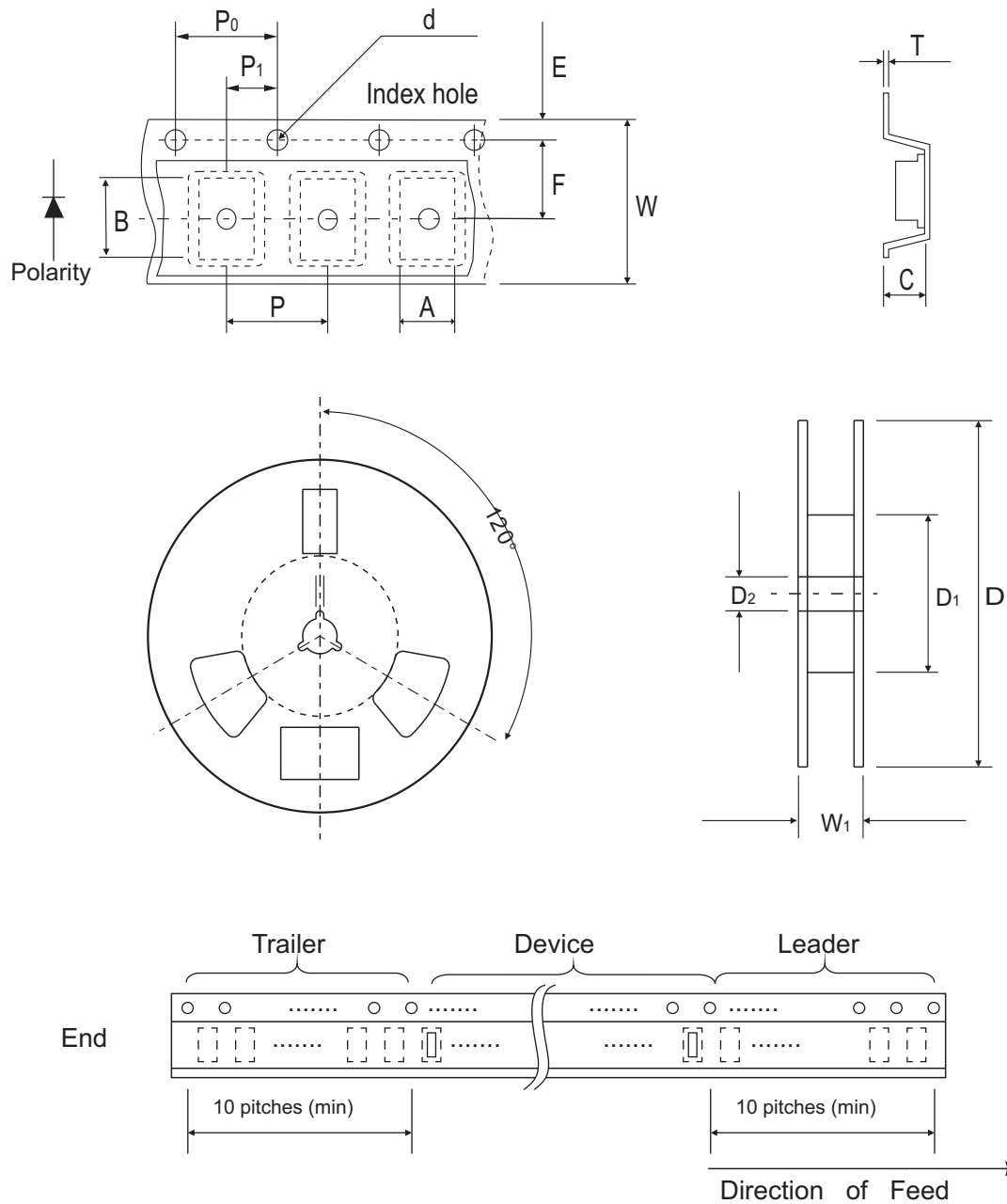


Fig.5 Non-repetitive Forward Surge Current



Reel Taping Specification

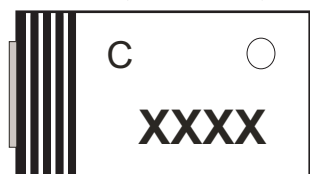


DO-214AC (SMA)	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	2.7 Max	5.3 Max	2.66 Max	1.50 ± 0.10 DIA	330 ± 2.00	50.0 Min.	13.5 ± 1.00
	(inch)	0.106 Max	0.209 Max	0.105 Max	0.059 ± 0.004 DIA	13.00 ± 0.079	1.969 Min.	0.531 ± 0.039

DO-214AC (SMA)	SYMBOL	E	F	P	P0	P1	W	W1
	(mm)	1.75 ± 0.10	5.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	12.0 ± 0.30	18.4 Max.
	(inch)	0.689 ± 0.004	0.216 ± 0.002	0.157 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	0.472 ± 0.012	0.724 Max

Marking Code

Comchip logo



Package:

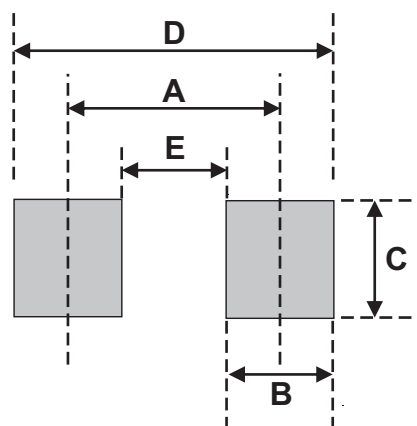
○	PKG
A	SMA
B	SMB
C	SMC

Product type marking code:

Part Number	Marking Code
CDBA220-G	B220
CDBA240-G	B240
CDBA260-G	B260
CDBA280-G	B280
CDBA2100-G	B2100

Suggested PAD Layout

SIZE	DO-214AC(SMA)	
	(mm)	(inch)
A	3.80	0.150
B	1.60	0.063
C	2.80	0.110
D	5.40	0.213
E	2.20	0.087



Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
DO-214AC (SMA)	5,000	13